

Product Description

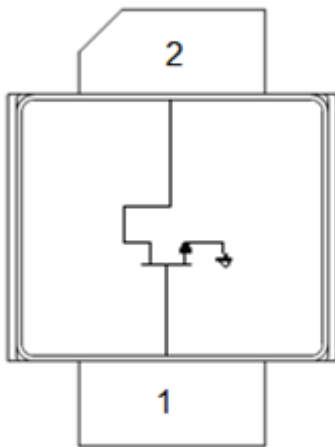
The QPD2194 is a discrete GaN on SiC HEMT which operates from 1.8-2.2 GHz. The device is a single stage pre-matched power amplifier transistor.

The QPD2194 can be used in Doherty architecture for the final stage of a base station power amplifier for macrocell high efficiency systems.

QPD2194 can deliver P_{SAT} of 371 W at +48 V operation.

Lead-free and ROHS compliant.

Functional Block Diagram



2 Lead NI400 Package

Product Features

- Operating Frequency Range: 1.8-2.2 GHz
- Operating Drain Voltage: +48 V
- Maximum Output Power (P_{SAT}): 371 W
- Maximum Drain Efficiency: 78.8%
- Efficiency-Tuned P3dB Gain: 18.0 dB
- 2-lead, earless, ceramic flange NI400 package

Applications

- W-CDMA / LTE
- Macrocell Base Station, B3-B1
- Active Antenna

Ordering Information

Part No.	ECCN	Description
QPD2194S2	EAR99	Box (2 Samples Each)
QPD2194SQ	EAR99	Tray (25 Samples)
QPD2194SR	EAR99	Reel (100 Samples)
QPD2194PCB4B01	EAR99	1.805-2.17 GHz Eval. Board



QPD2194

300 W, 48 V, 1.8-2.2 GHz GaN RF Power Transistor

Absolute Maximum Ratings

Parameter	Value / Range
Gate Current (I_G)	-48 to 48 mA
Drain Voltage (V_D)	+55 V
Peak RF Input Power	44 dBm
VSWR Mismatch, P1dB Pulse (10 % duty cycle, 100 μ width), T = 25 °C	10:1
Storage Temperature	-65 to +150°C

Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating

Parameter	Min	Typ	Max	Units
Operating Temperature	-40	-	-	°C
Gate Voltage (V_G)	-	-2.7	-	V
Drain Voltage (V_D)	-	48	-	V
Quiescent Current (I_{DQ})	-	600	-	mA
T_{CH} for >10 ⁶ hours MTTF	-	-	250	°C

Electrical performance is measured under conditions noted in the electrical specifications table. Specifications are not guaranteed over all recommended operating conditions.

RF Characterization

Parameter	Conditions	Min	Typ	Max	Units
Frequency Range		1805	-	2170	MHz
Quiescent Current		-	600	-	mA
Linear Gain		-	19.1	-	dB
P3dB		-	55.0	-	dBm
Drain Efficiency	P3dB	-	60.0	-	%

Test conditions unless otherwise noted: $V_D = +48$ V, $I_{DQ} = 600$ mA, T = 25°C, Pulsed CW (10% duty cycle, 100 μ s width) on Class AB single-ended EVB at 1880 MHz

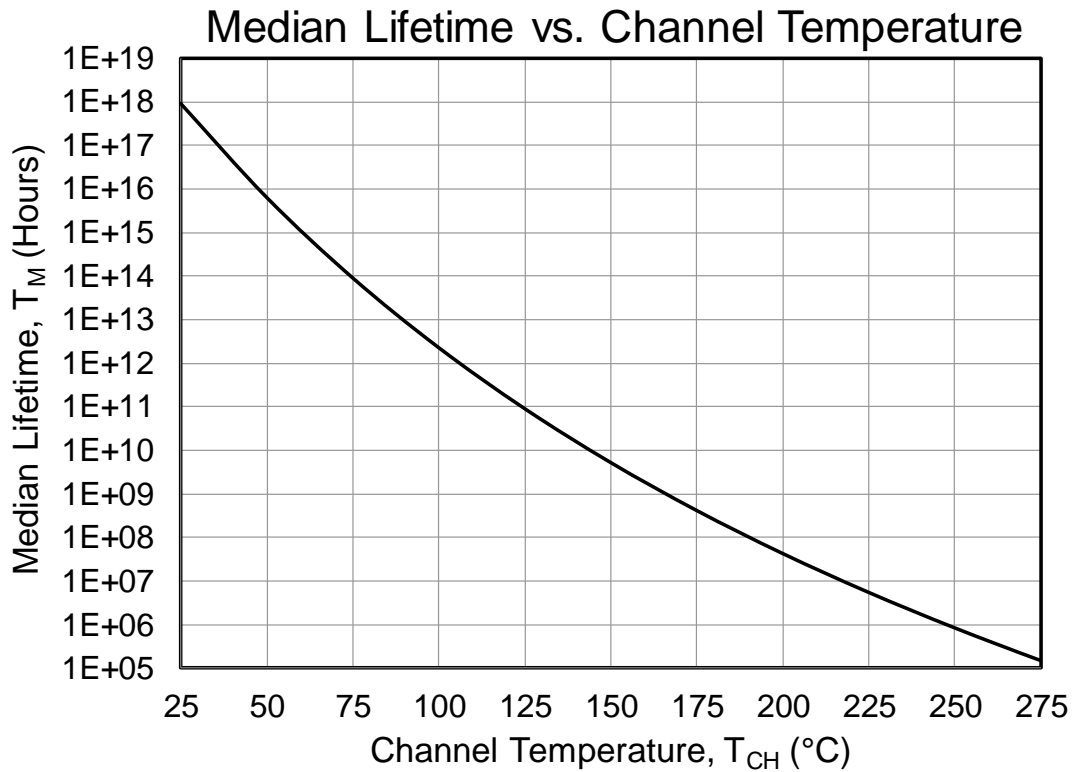
Thermal and Reliability Information

Parameter	Test Conditions	Value	Units
Carrier Amplifier Thermal Resistance at Average Power (θ_{JC})	$T_{CASE} = 85^{\circ}C$, $T_{CH} = 152^{\circ}C$, CW: $P_{DISS} = 60W$, $P_{OUT} = 90W$	1.12	$^{\circ}C/W$

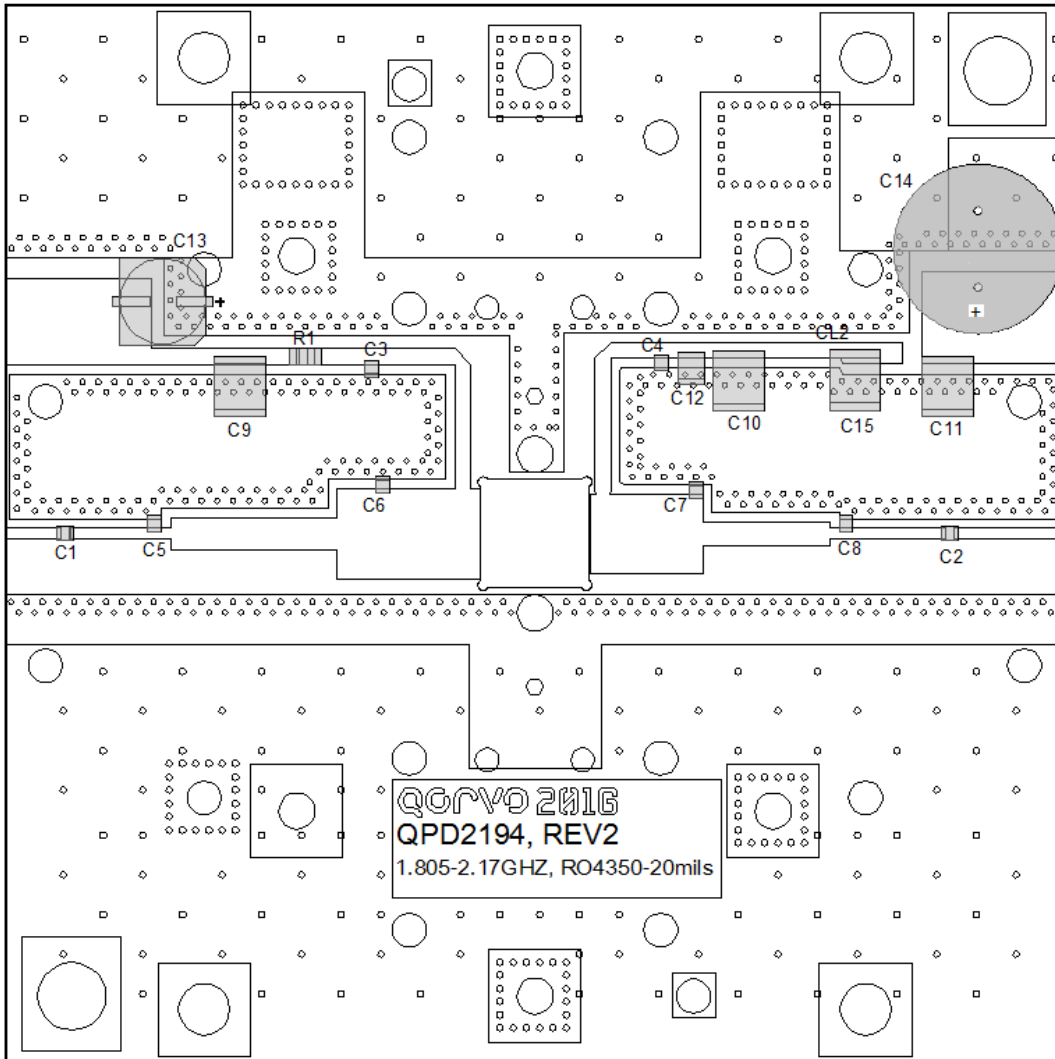
Notes:

1. Thermal resistance measured to package backside.
2. Based on expected carrier amplifier efficiency of Doherty.
3. P_{OUT} assumes 20% peaking amplifier contribution of total average Doherty rated power.

Median Lifetime



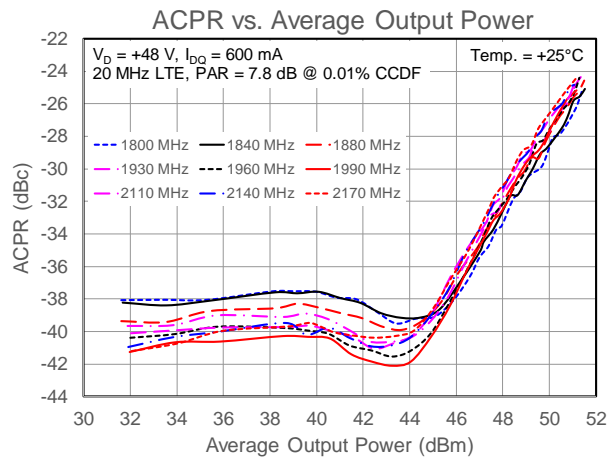
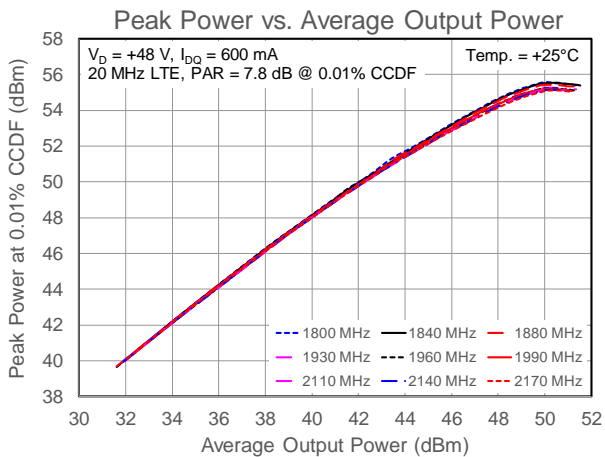
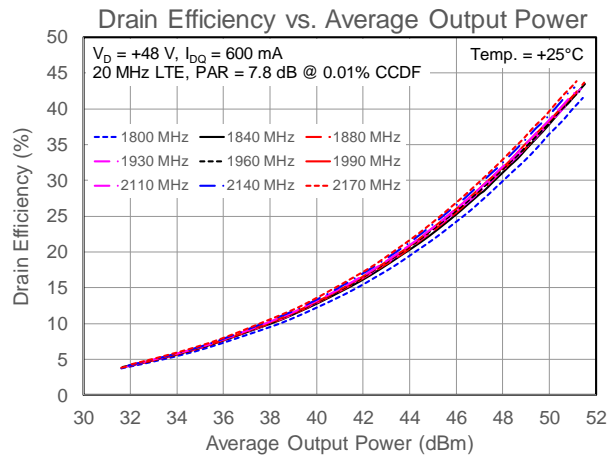
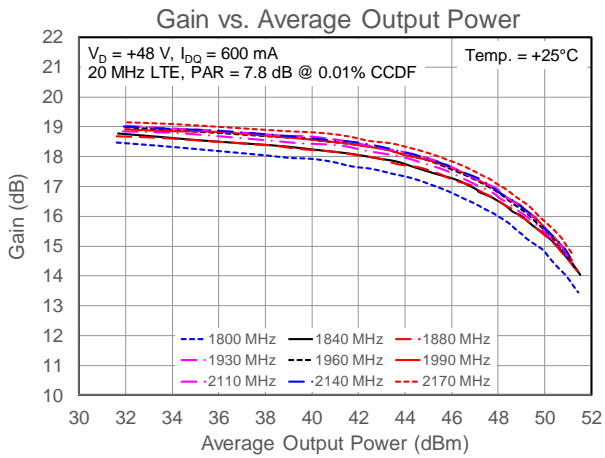
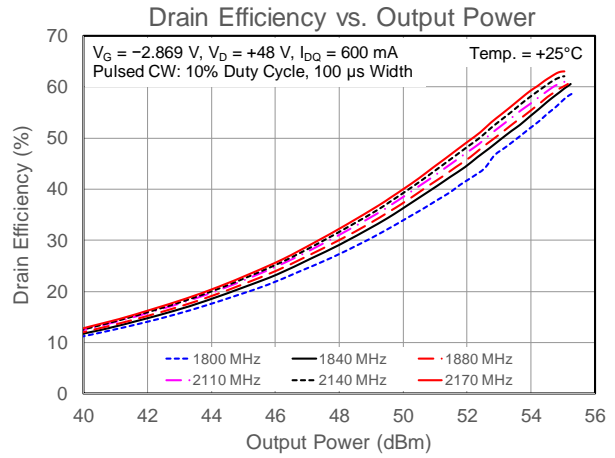
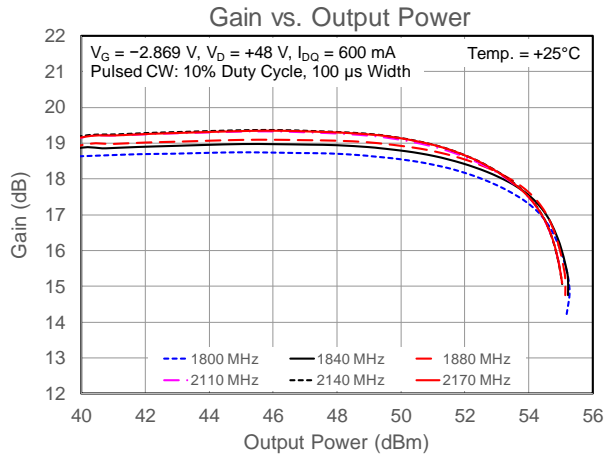
Single-Ended Evaluation Board Layout



Bill of Materials

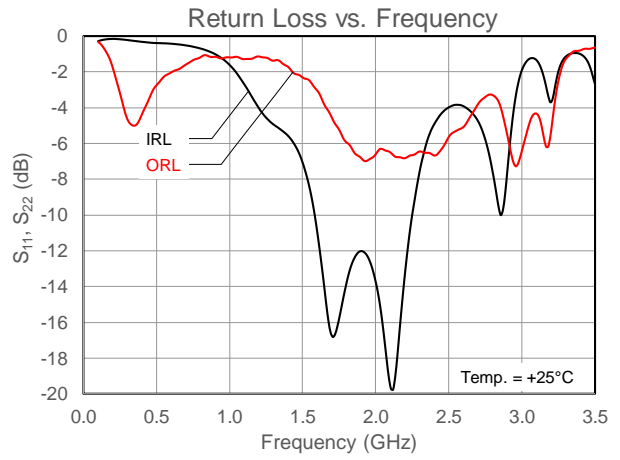
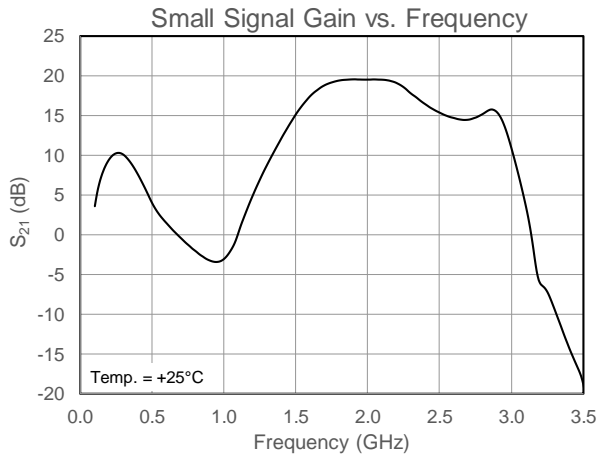
Reference Des.	Value	Description	Manuf.	Part Number
C1, C2, C3, C4	33 pF	Capacitor, 33 pF, 5%, 250 V	ATC	ATC800A330JT
C5	1.2 oF	Capacitor, 1.2 pF, ±0.1 pF, 250 V	ATC	ATC800A1R2BT250X
C6	1.9 pF	Capacitor, 1.9 pF, ±0.1 pF, 250 V	ATC	ATC800A1R9BT250X
C7	2.2 pF	Capacitor, 2.2 pF, ±0.1 pF, 250 V	ATC	ATC800A2R2BT250X
C8	0.8 pF	Capacitor, 0.8 pF, ±0.1 pF, 250 V	ATC	ATC800A0R8BT250X
C9, C10, C11, C15	4.7 µF	Capacitor, 4.7 µF, 10%, 100 V, X7R	Murata	GRM55ER72A475KA01L
C12	1 µF	Capacitor, 1 µF, 10%, 100 V, X7R	Murata	GRM32NR72A104KA01L
C13	100 µF	Capacitor, 100 µF, ±20%, 50 V, electrolytic	Panasonic	EEE-1HA101UAP
C14	220 µF	Capacitor, 220 µF, 20%, 100 V, electrolytic	Cornell	AFK227M2AR44T-F
R1	10 Ω	Resistor, 10 Ω, 1%, 1/4 W, 1206	Panasonic	ERJ-8ENF10R0V

Single-Ended Evaluation Board Performance Plots



Test conditions unless otherwise noted: $V_D = +48\text{ V}$, $I_{DQ} = 600\text{ mA}$, $T = 25^\circ\text{C}$, on Class AB single-ended EVB

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RF Characterization – Power-Tuned Load Pull Performance

Frequency (MHz)	Source Impedance	Load Impedance	Gain @ P3dB (dB)	P3dB (dBm)	Drain Efficiency (%)
1800	6.21 – j1.70	6.15 – j5.81	15.1	55.4	54.0
1840	2.31 – j5.94	6.15 – j5.82	15.9	55.7	57.0
1880	4.21 – j2.56	6.00 – j4.30	16.4	55.7	62.5
2110	4.06 – j5.02	6.52 – j2.92	16.4	55.6	66.6
2140	4.24 – j5.12	8.50 – j2.10	15.7	55.6	59.4
2170	1.55 – j2.71	8.00 – j2.10	16.1	55.6	62.2

Test conditions unless otherwise noted: $V_D = +48$ V, $I_{DQ} = 600$ mA, $T = 25^\circ\text{C}$, Pulsed (10% duty cycle, 100 μs width)

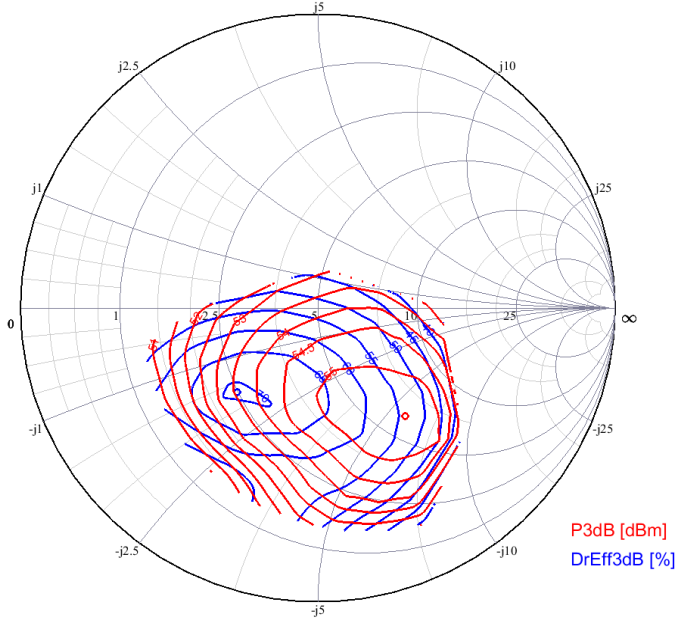
RF Characterization – Efficiency-Tuned Load Pull Performance

Frequency (MHz)	Source Impedance	Load Impedance	Gain @ P3dB (dB)	P3dB (dBm)	Drain Efficiency (%)
1800	6.21 – j1.70	2.50 – j1.70	16.8	53.6	70.9
1840	2.31 – j5.94	2.92 – j2.22	17.6	54.3	73.3
1880	4.21 – j2.56	2.53 – j2.80	18.0	54.1	78.8
2110	4.06 – j5.02	2.14 – j3.38	17.6	52.6	78.4
2140	4.24 – j5.12	3.30 – j3.90	17.5	53.8	75.7
2170	1.55 – j2.71	2.23 – j4.27	18.0	52.2	77.7

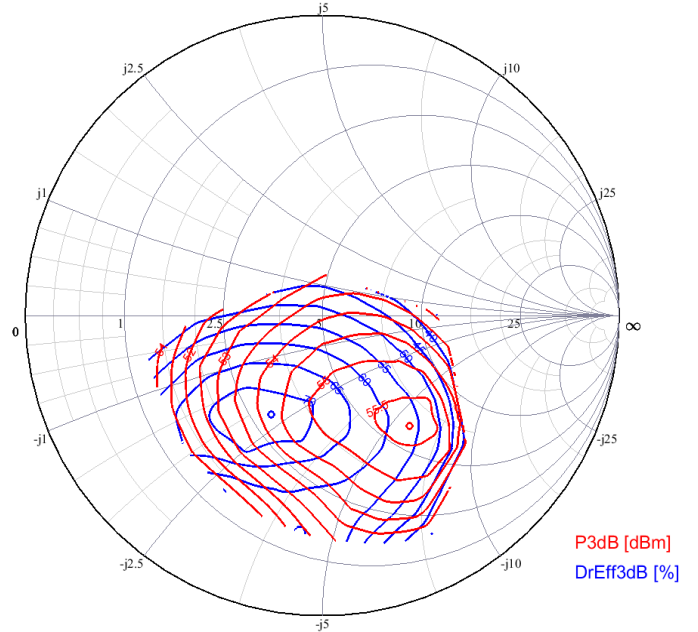
Test conditions unless otherwise noted: $V_D = +48$ V, $I_{DQ} = 600$ mA, $T = 25^\circ\text{C}$, Pulsed (10% duty cycle, 100 μs width)

Load Pull Plots

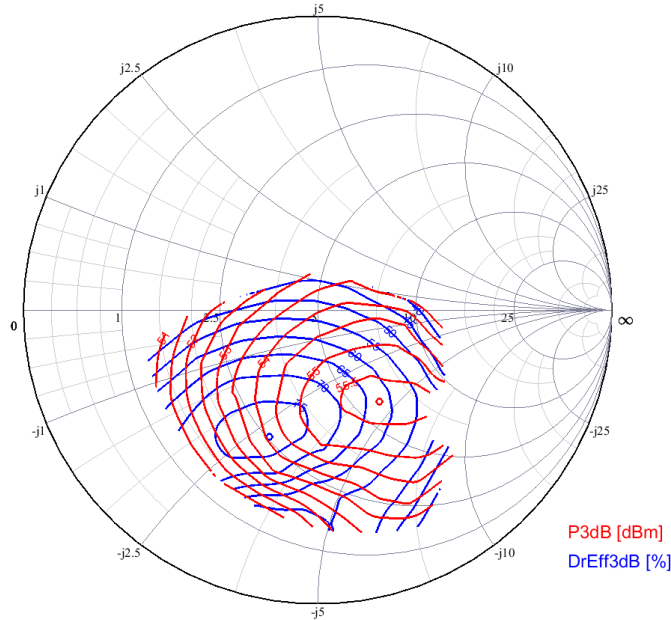
Load Pull at 1.8 GHz



Load Pull at 1.84 GHz



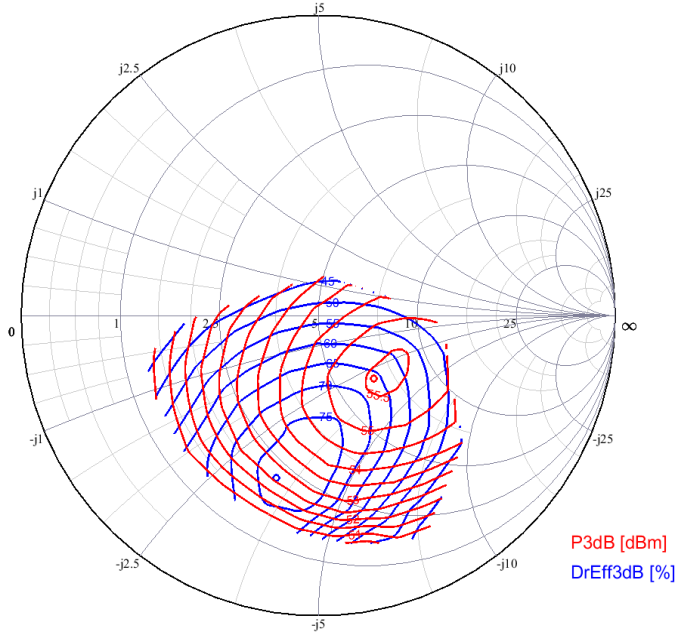
Load Pull at 1.88 GHz



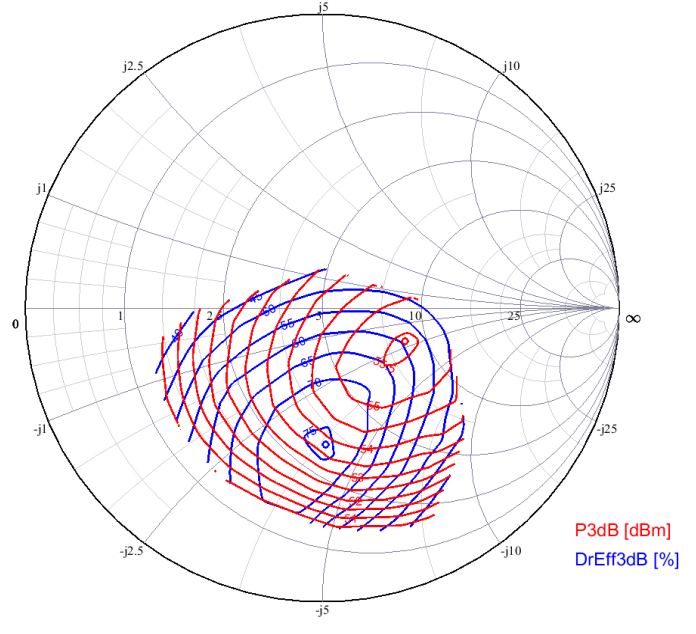
Test conditions unless otherwise noted: $V_D = +48\text{ V}$, $I_{DQ} = 600\text{ mA}$, $T = 25^\circ\text{C}$, Pulsed (10% duty cycle, 100 μs width)

Load Pull Plots

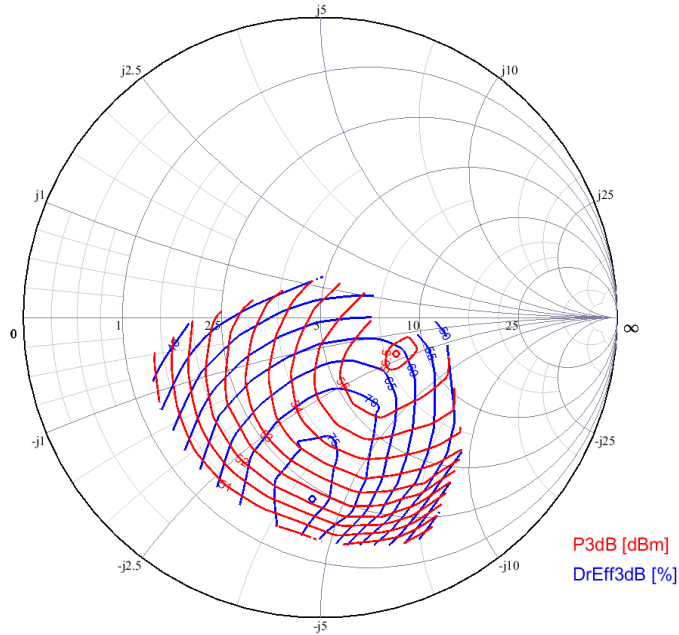
Load Pull at 2.11 GHz



Load Pull at 2.14 GHz

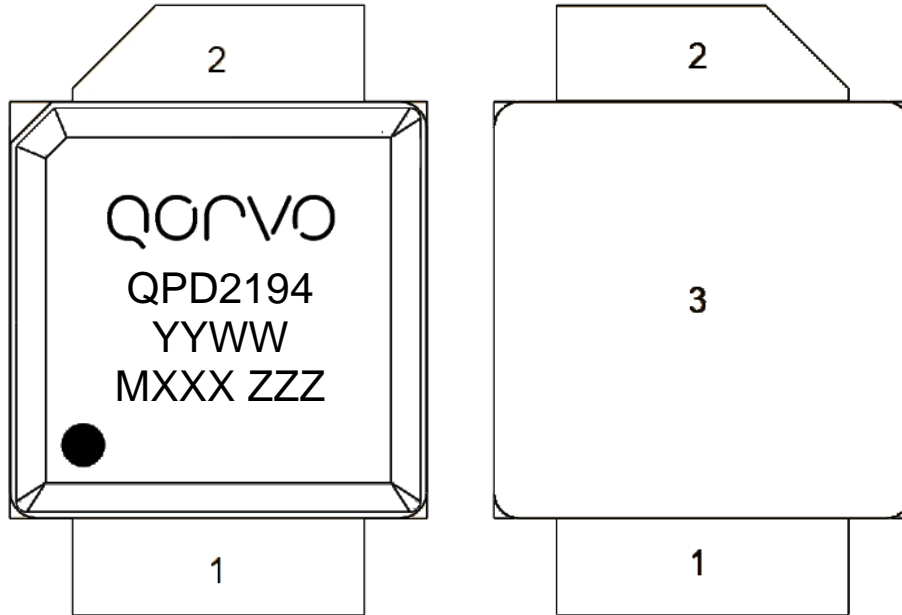


Load Pull at 2.17 GHz



Test conditions unless otherwise noted: $V_D = +48\text{ V}$, $I_{DQ} = 600\text{ mA}$, $T = 25^\circ\text{C}$, Pulsed (10% duty cycle, 100 μs width)

Pin Configuration

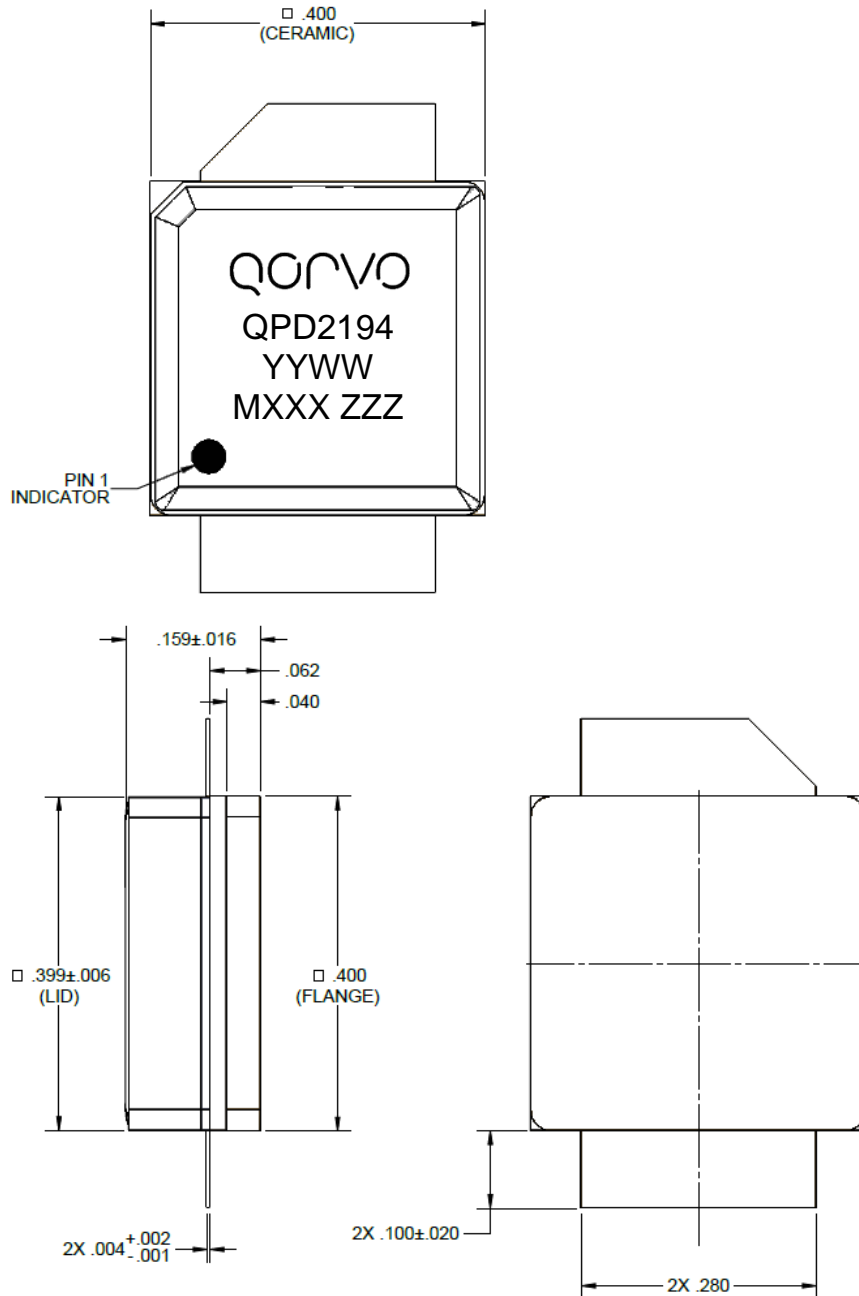


Pin Description

Pin No.	Label	Description
1	RF IN, VG	RF Input, Gate Bias
2	RF OUT, VD	RF Output, Drain Bias
3 (Backside Paddle)	RF/DC GND	RF/DC Ground

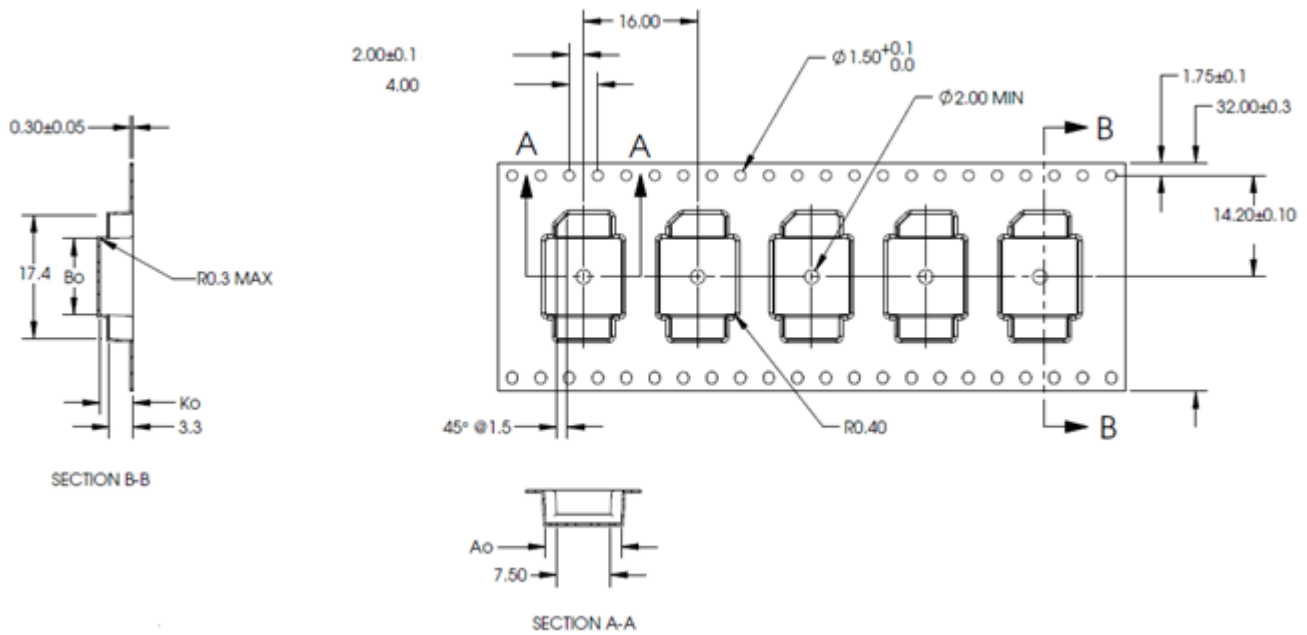
Package Marking and Dimensions

Marking: Qorvo Logo
 Part Number and Package Version – QPD2194
 Date Code – YYWW
 Production Lot Number – MXXX
 Serial Number – ZZZ



Notes:
 1. All dimensions are in inches. Angles are in degrees.
 2. Exposed metallization is NiAu plated.

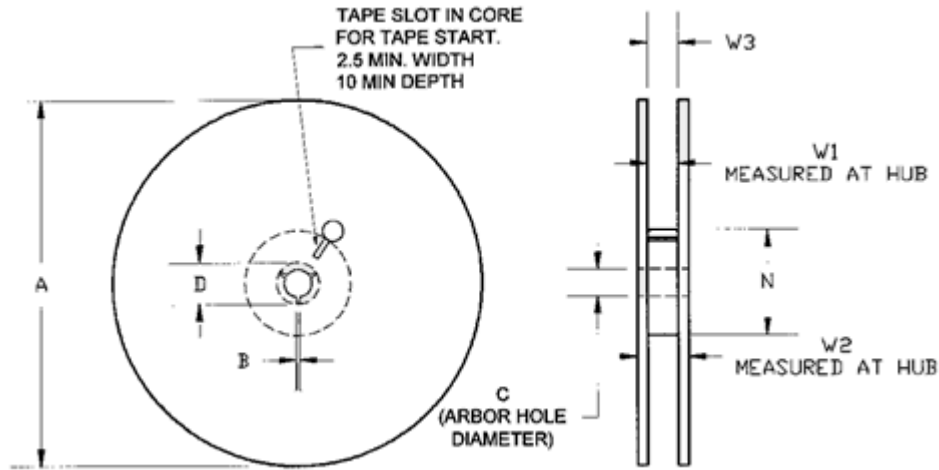
Tape and Reel Information – Carrier and Cover Tape Dimensions



Feature	Measure	Symbol	Size (in)	Size (mm)
Cavity	Length	A0	0.417	10.60
	Width	B0	0.419	10.65
	Depth	K0	0.181	4.60
	Pitch	P1	0.630	16
Centerline Distance	Cavity to Perforation – Length Direction	P2	0.079	2.00
	Cavity to Perforation – Width Direction	F	0.559	14.20
Cover Tape	Width	C	1.004	25.50
Carrier Tape	Width	W	1.260	32

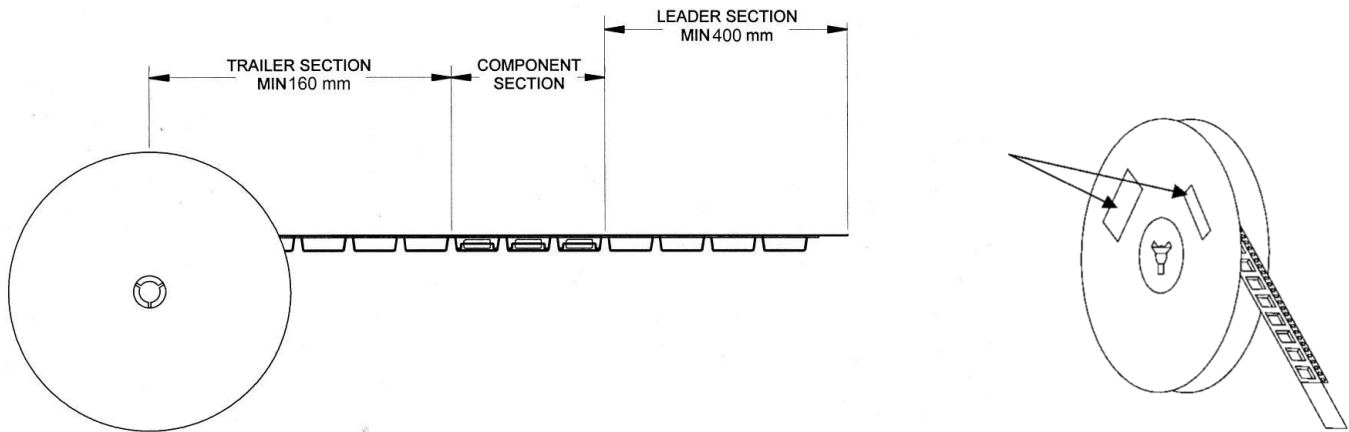
Tape and Reel Information – Reel Dimensions

Standard T/R size = 100 pieces on a 13" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
Flange	Diameter	A	12.992	330.0
	Thickness	W2	1.504	38.2
	Space Between Flange	W1	1.291	32.8
Hub	Outer Diameter	N	4.016	102.0
	Arbor Hole Diameter	C	0.512	13.0
	Key Slit Width	B	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

Tape and Reel Information – Tape Length and Label Placement



Notes:

1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
2. Labels are placed on the flange opposite the sprockets in the carrier tape.